

## Typical Applications

*Satellite Communications  
Military*

## Features

*Surface Mount  
High Reliability  
Designed to Withstand 50 Krads Total Dose  
(Optional to 100 Krads Total Dose)*

## Frequency

**10 MHz – 75 MHz**

## Parameters

### Output

Rise and Fall Time:  
10 MHz to 20 MHz  
20 MHz to 75 MHz

Duty Cycle:

Logic "0"

Logic "1"

### TTL

Meas. 0.8 V & 2.0 V  
15 ns max.  
5 ns max.  
40/60% @ 1.4 V level  
+ 0.5 V max.  
+ 2.4 V min.

### CMOS

Meas. 10% to 90%  
5 ns max.  
5 ns max.  
40/60% @ 50% level  
+ 0.5 V max.  
+ 4.0 V min.

Load:

Temperature Stability:

Aging:

Calibration (factory):

Electrical Frequency Adjustment:  
(when specified)<sup>1</sup>

Screening:

Environmental:

Short Term Stability:

As defined by MIL-PRF-55310

± 2 to ± 4 ppm max. typical over -40° to +85°C

± 5 to ± 10 ppm max. typical over -55° to +105°C

± 1 to ± 2 ppm/year depending on frequency

± 4 ppm @ 25°C (if EFC is not specified)

± 5 ppm min.

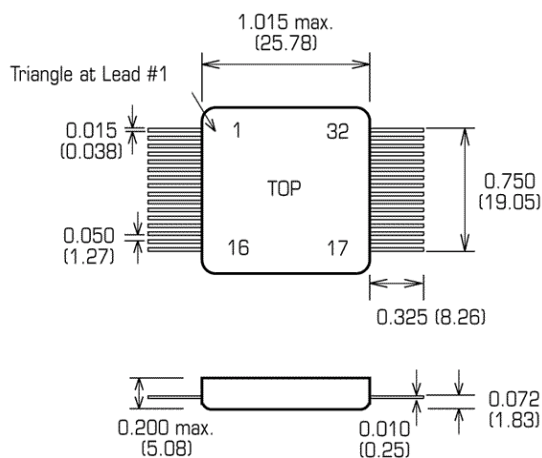
Class B or Class S

Random Vibration: 50 g typical

Shock: 1500 g, 0.5 msec. typical

± 1 x 10<sup>-9</sup> per second typical

## Enclosure



Dimensions: Inches (mm)

### Typical Phase Noise @ 10 MHz

1Hz Offset	- 55 dBc / Hz
10Hz Offset	-85 dBc / Hz
100Hz Offset	-115 dBc / Hz
1kHz Offset	-135dBc / Hz
10kHz Offset	-145dBc / Hz
100kHz Offset	-145dBc / Hz

## PIN CONNECTIONS

- 4 – Ext. Freq. Adj. (when specified),  
or N/C
- 5 – GND/Case
- 11 – Supply Voltage
- 12 – RF Output
- 13 – Supply Voltage

Notes: Leads 11 and 13 are connected internally; either  
or both may be used.

Optional lead forming available for surface mounting.  
<sup>1</sup>External Frequency Adjustment is required for calibration  
@ +25°C for frequency stability specifications of < ±4 ppm.